

Sensors and Materials

Special Issue on Sensor Technology

Call for Papers

Sensors are used in everyday life to measure strength, distance, height, and pressure, and so forth. They are also widely used in intelligent manufacturing and IoT. This special issue focuses on sensors used in everyday life, manufacturing, and IoT applications, including materials, systems, design, and manufacturing techniques. Such materials include carbon, metals, ceramics, polymers, and related composite materials. In addition, papers on sensor applications of biomolecular materials, microorganisms, and various organic and inorganic materials are all welcomed.

Scope:

Sensor design

Sensor applications

Sensor materials

Sensor fabrication

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